EAST Search History

Ref #	Hits	Search Query	DBs	Default Operat or	Plural s	Time Stamp
L1	142	((underfill or filler)near5(particle adj size)near5 (("32" or "300" or "60")near5 microns))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/04/01 15:40
L5	40	((underfill or encapsulant) same (filler near5(particle adj size)near5 microns))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/04/01 15:43
L6	26	("2896462" "3023174" "3507831" "3759954" "3879422" "3956317" "4153586" "4159221" "5512613" "5560934"). PN. OR ("5932682"). URPN.	US-PGPU B; USPAT; USOCR	OR	ON	2007/04/01 15:57

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C:\Documents and Settings\maboagye\My Documents\EAST\Workspaces\10711501 solder interconnect array with optimal mechanical int